

LENNOO 聯宇電子股份有限公司

LENNOO ELECTRONICS CO., LTD.

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APPROVAL SHEET

CUSTOMER: _____

CUSTOMER PART NO. _____

TYPE NO.: L034SWC-2ZWH1

PACKAGE SIZE: 3.0mm Round Type LED Lamp

DICE MATERIAL: InGaN Chromaticity Coordinate: x=0.29 y=0.31

EMITTED COLOR: White VIEWING ANGLE (deg): 30

LENS COLOR: Water Clear IV(mcd): 11000

CUSTOMER
ENGINEERING DEPARTMENT

LENNOO ELECTRONICS CO., LTD.
ENGINEERING DEPARTMENT

(Authorized Signature)

APPROVED DATE _____

ISSUED DATE _____

LENOO ELECTRONICS CO., LTD.

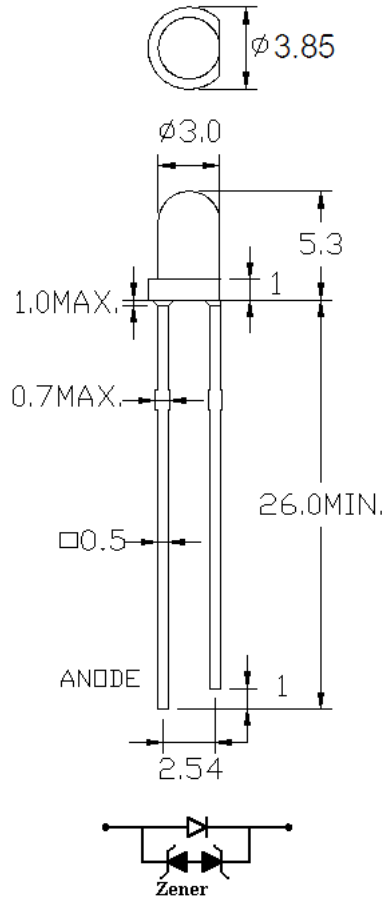
TYPE NO. : L034SWC-2ZWH1

ELECTRICAL / OPTICAL CHARACTERISTICS AT Ta = 25°C

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST
Luminous Intensity	IV	4900	11000	16500	mcd	IF = 20mA
Viewing Angle	2 θ 1/2		30		deg	
Chromaticity Coordinate	X		0.29		nm	
Chromaticity Coordinate	Y		0.31		nm	
Spectral Line Half-Width	$\Delta\lambda$				nm	
Forward Voltage	VF	2.8	3.1	3.5	V	
Power Dissipation	Pd			85	mW	
Peak Forward Current (Duty1/10 @ 1KHZ)	IF (Peak)			100	mA	
Recommended Operating Current	IF (Rec)		20		mA	

● ABSOLUTE MAXIMUM RATINGS : (Ta = 25°C)

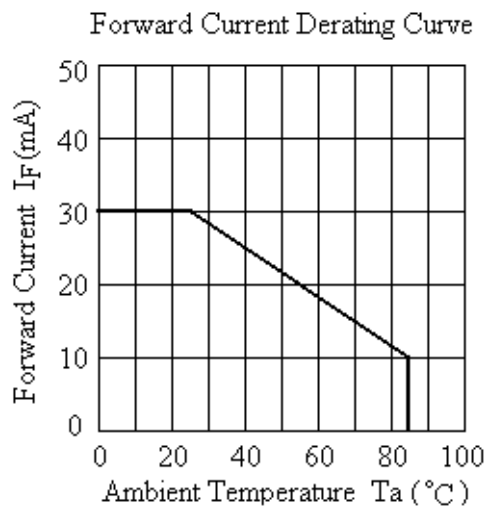
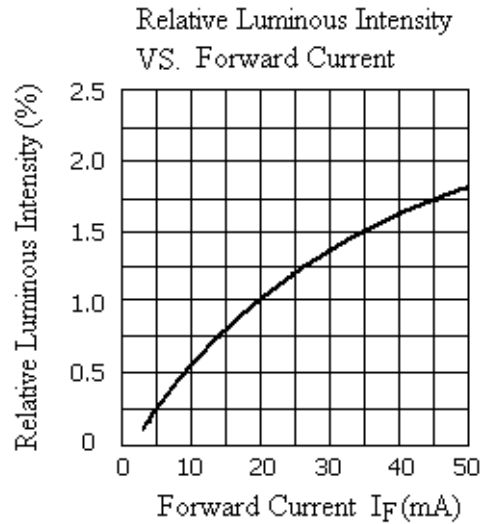
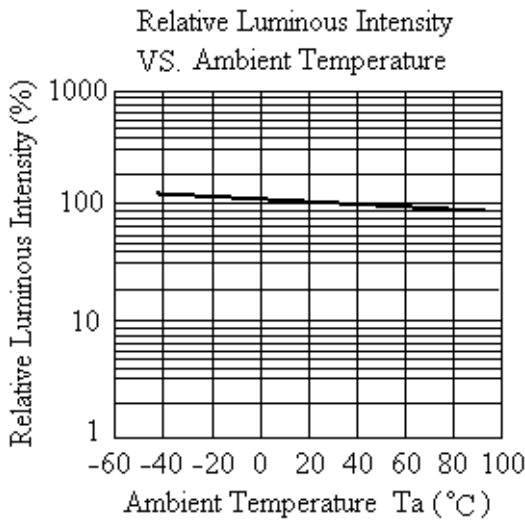
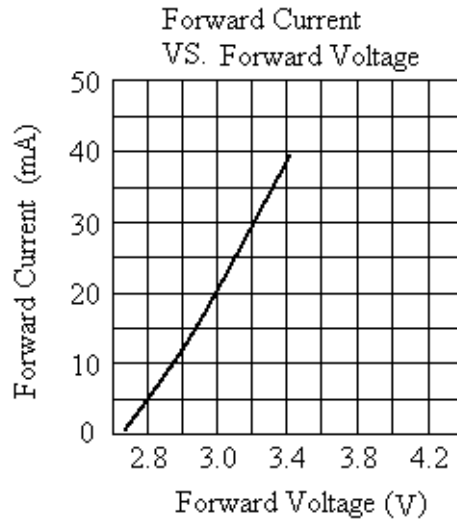
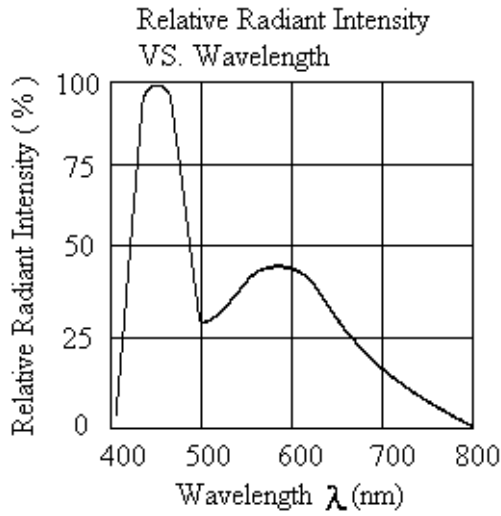
Reverse Voltage	: 5 Volt
Reverse Current	: 10 uA (VR=5V)
Electrostatics Discharge (ESD)	: 2000 Volt
Operating Temperature Range	: -40°C TO 85°C
Storage Temperature Range	: -40°C TO 100°C
Lead Soldering Temperature Range 【 1.6 mm (1/16 inch) from body 】	: 260°C For 5 Seconds



<p>DEVICE NO.: L034SWC-2ZWH1</p>	<p>DRAWING NO.</p>	<p>ENGINEER</p>
<p>ALL TOLERANCE SHALL BE ±0.01 inch/0.25mm UNLESS OTHERWISE NOTED</p>	<p>DRAWING DATE</p>	<p>APPROVER</p>

White Typical Electrical Optical Characteristics Curves

($T_a=25^{\circ}\text{C}$ Ambient Temperature Unless Otherwise Noted)



Bin Code Explanation

Bin Code:

VF: Bin Range of Forward Voltage (Unit: V)

BIN A: 1.0~1.2	BIN B: 1.2~1.4	BIN C: 1.4~1.6	BIN D: 1.6~1.8	BIN E: 1.8~2.0
BIN F: 2.0~2.2	BIN G: 2.2~2.4	BIN H: 2.4~2.6	BIN I: 2.6~2.8	BIN J: 2.8~3.0
BIN K: 3.0~3.2	BIN L: 3.2~3.4	BIN M: 3.4~3.6	BIN N: 3.6~3.8	BIN P: 3.8~4.0
BIN Q: 4.0~4.2	BIN R: 4.2~4.4	BIN S: 4.4~4.6	BIN T: 4.6~4.8	

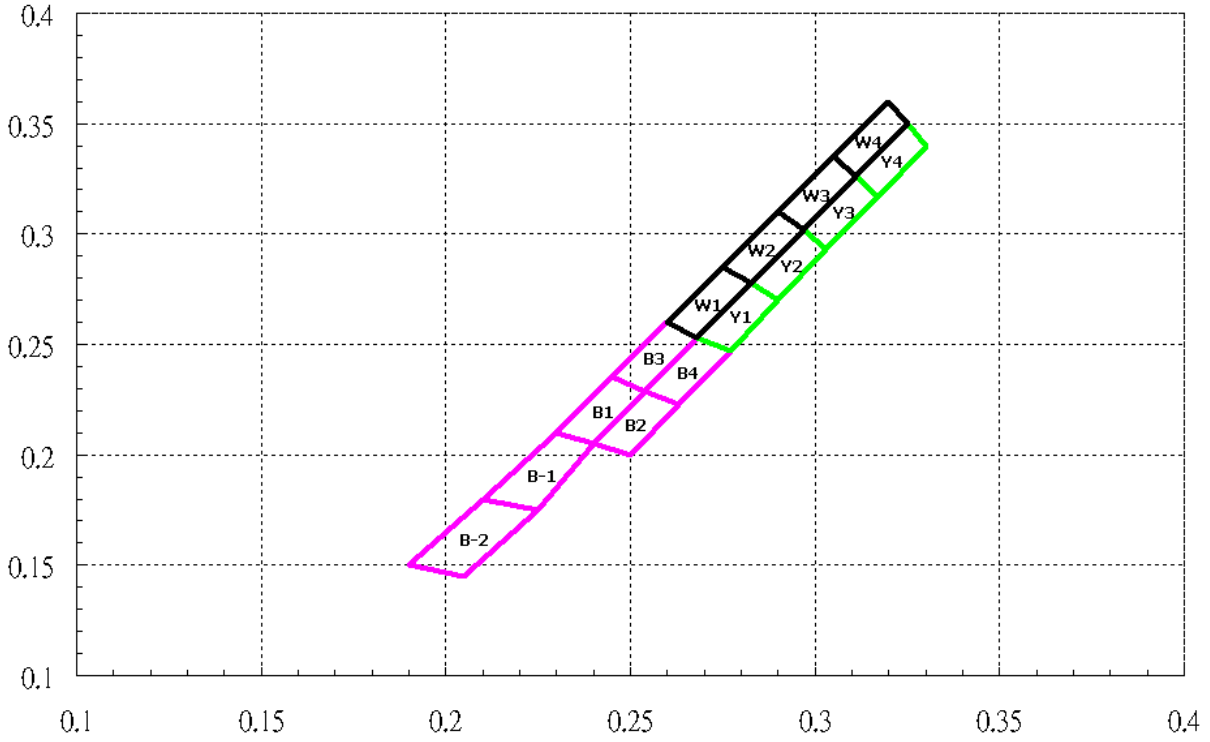
IV:

Bin Range of Luminous Intensity (Unit: mcd)

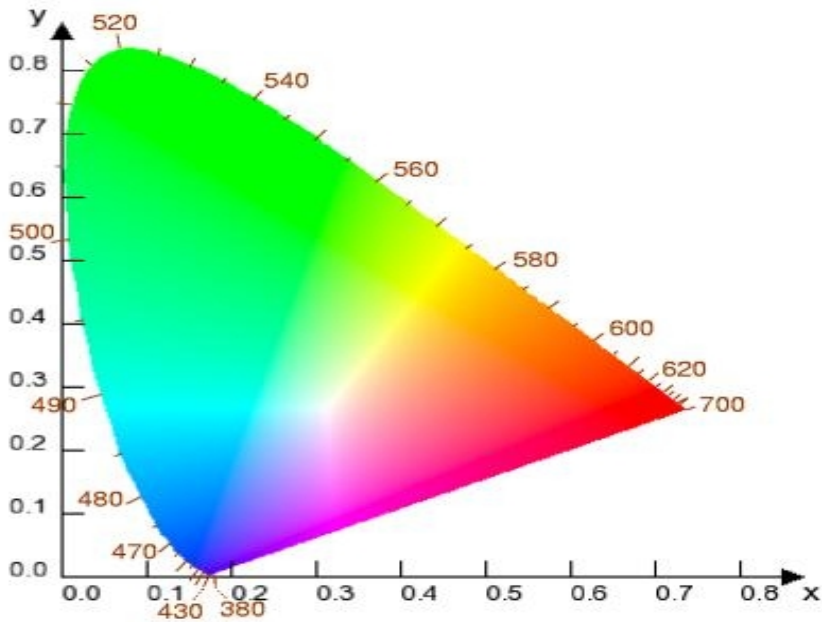
BIN 1: 0.1~4	BIN 2: 4~6	BIN 3: 6~9:	BIN 4: 9~13	BIN 5: 13~19
BIN 6: 19~28	BIN 7: 28~42	BIN 8: 42~63	BIN 9: 63~94	BIN 10: 94~140
BIN 11: 140~210	BIN 12: 210~310	BIN 13: 310~460	BIN 14: 460~690	BIN 15: 690~1000
BIN 16: 1000~1500	BIN 17: 1500~2200	BIN 18: 2200~3300	BIN 19: 3300~4900	BIN 20: 4900~7300
BIN 21: 7300~11000	BIN 22: 11000~16500	BIN 23: 16500~25000	BIN 24: 25000~32000	BIN 25: 32000~40000
BIN 26: 40000~50000	BIN 27: 50000~60000			

XY: Color Rank (White)

BIN CODE	Left		Top		Right		Bottom	
	X1	Y1	X2	Y2	X3	Y3	X4	Y4
BIN B-1	0.21	0.18	0.23	0.21	0.24	0.205	0.225	0.175
BIN B-2	0.19	0.15	0.21	0.18	0.225	0.175	0.205	0.145
BIN B1	0.23	0.21	0.245	0.235	0.254	0.229	0.24	0.205
BIN B2	0.24	0.205	0.254	0.229	0.263	0.223	0.25	0.2
BIN B3	0.245	0.235	0.26	0.26	0.268	0.253	0.254	0.229
BIN B4	0.254	0.229	0.268	0.253	0.277	0.247	0.263	0.223
BIN W1	0.26	0.26	0.275	0.285	0.283	0.278	0.268	0.253
BIN Y1	0.268	0.253	0.283	0.278	0.29	0.27	0.277	0.247
BIN W2	0.275	0.285	0.29	0.31	0.297	0.302	0.283	0.278
BIN Y2	0.283	0.278	0.297	0.302	0.303	0.293	0.29	0.27
BIN W3	0.29	0.31	0.305	0.335	0.311	0.326	0.297	0.302
BIN Y3	0.297	0.302	0.311	0.326	0.317	0.317	0.303	0.293
BIN W4	0.305	0.335	0.32	0.36	0.325	0.35	0.311	0.326
BIN Y4	0.311	0.326	0.325	0.35	0.33	0.34	0.317	0.317



CIE chromaticity Coordinates Diagram

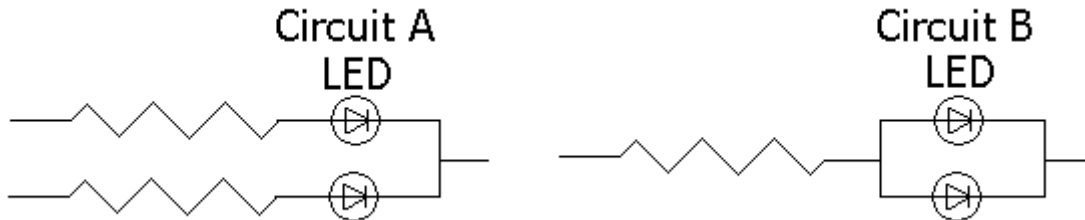


Reliability test For LED Lamps**Type No. :L034SWC-2ZWH1**

NO.	Item	Test Conditions	Test Time/ Cycle	Sample Size	Ac/Re
1	DC Operating Life	Temperature:25°C IF:20mA	1000HRS	20PCS	0/1
2	High Temperature High Humidity	Temperature:85°C 85%RH	1000HRS	20PCS	0/1
3	High Temperature Storage	Temperature:100°C	1000HRS	20PCS	0/1
4	Low Temperature Storage	Temperature: -40°C	1000HRS	20PCS	0/1
5	Temperature Cycling	85°C~25°C~-35°C 15min~5min~15min	15Cycles	20PCS	0/1
6	Thermal Shock	85°C~25°C~-10°C 5min~10sec~5min	15Cycles	20PCS	0/1
7	Solder Heat	Temperature:260°C±5°C	10SEC.	20PCS	0/1

Precautions For Use LED**1. Drive Method**

LED is current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in a application, it is recommended that a current limiting resistor be incorporated in the drive circuit.



(a) Circuit A it is recommended circuit.

(b) Circuit B the brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

2. Over-current-proof

Customer must apply resistors for protection , otherwise slight voltage shift will cause big current change(Burn out will happen).

3. Storage

The Storage Temperature and RH are: $5^{\circ}\text{C} \sim 30^{\circ}\text{C}$, RH 60% or less.

Once the package is opened, the products should be used with in a week. Otherwise, they should be kept in moisture proof package with moisture absorbent material (silica gel).

we suggest our customers to use our products within a year.

If the moisture absorbent material (silica gel) has faded away or the LEDs exceeded the storage time , baking treatment should be performed using the following conditions.

Baking treatment: more than 24 hours at $60^{\circ}\text{C} \pm 5^{\circ}\text{C}$.

4. Electrostatic Discharge (ESD)

Static electricity or surge voltage will damage the LEDs

Suggestions to prevent ESD damage:

Use of a conductive wrist band or ante-electrostatic glove when handing these LEDs

All devices, equipment, and machinery must be properly grounded.

Work tables storage racks, etc. should be properly grounded

In the events of manual working in process, make sure the devices are well protected from ESD at any time.

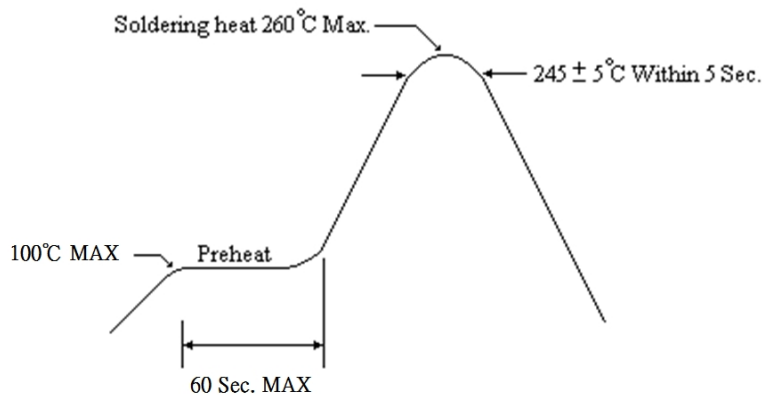
5. Others

- (a) If want to have the uniform luminance and color, please use the same binning number, and avoid using intermix to cause the differences of luminance and color.
- (b) The appearance and specifications of the product may be modified for improvement without prior notice.

6. Soldering

Recommended soldering condition as shown below:

Soldering heat (DIP)



Soldering Iron

Temperature at tip of iron : 350°C Max.

Soldering Time: 3 sec. ± 1 sec. (one time only)

If temperature is higher, time should be shorter

Reflow Temp./Time(SMD)

